

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re the Application of

DONALD C. ABBOTT ET AL.

Serial No. 09/525,105 (TI-28098.1)

Filed: Herewith

For: SEMICONDUCTOR CIRCUIT ASSEMBLY HAVING PLATED LEADFRAME  
INCLUDING GOLD SELECTIVELY COVERING AREAS TO BE SOLDERED

Art Unit

Examiner

Director of the United States  
Patent and Trademark Office  
P.O. Box 1450  
Alexandria, VA 22313-1450

**PRELIMINARY AMENDMENT**

Dear Sir:

Prior to the first Office action, please amend the above-identified application as follows:

**In the claims:**

Cancel claims 1 to 16.

**REMARKS**

The claims elected in the parent application have been canceled, leaving claims 17 to 22 which were subject to a requirement for restriction in the parent application

Action and allowance are respectfully requested.

Respectfully submitted,



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